

C1206C330J5RACTU

Specifications

Insulation Resistance

Aliases (C1206C330J5RAC7800) SMD Comm X7R, Ceramic, 33 pF, 5%, 50 VDC, X7R, SMD, MLCC, Temperature Stable, Class II, 1206, 1.5 mm



General Information	
Series	SMD Comm X7R
Style	SMD Chip
Description	SMD, MLCC, Temperature Stable, Class II
Features	Temperature Stable, Class II
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	17 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	1206
L	3.2mm +/-0.2mm
W	1.6mm +/-0.2mm
Т	0.78mm +/-0.10mm
S	1.5mm MIN
В	0.5mm +/-0.25mm

	Capacitance	33 pF
	Measurement Condition	1 kHz 1.0Vrms
	Tolerance	5%
	Voltage DC	50 VDC
	Dielectric Withstanding Voltage	125 VDC
	Temperature Range	-55/+125°C
	Temp. Coefficient	X7R
	Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
	Dissipation Factor	2.5% 1 kHz 1.0Vrms
	Aging Rate	3% Loss/Decade Hour: Referee

Time is 1000 Hours

100 GOhms

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	4000

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